SH: Wireless Smart Multi-sensor Devices Hiroshi Imamoto

Keywords: wireless, multi-sensor, MEMS

Miniature Wireless Sensor Modules to be used in a Clean Room.
Monitor environment & detect events to cut Energy consumption.

Introduction

Abstract

- As small as 3*3*1cm module has 3 sensors, RF module, CPU, & Battery in it.
- Monitors Temperature, Humidity, Illumination, Pressure, Air-flow, Acceleration, and more.
- 50 to 100 modules can operate in a system.
- To operate 660hours with 10min. interval.

Methods

- Adopt small sized & low power components.
- Embed MEMS and ME sensors, including those developed in BEANS projects.
- Unique wireless communication technique will allow periodic monitoring & event detection in the same system.

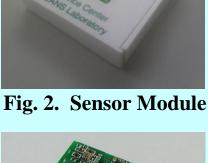




Fig. 3. PCB

Results

Example of server display

1	bits all a			lan the			lan ilan		_
No.	センサ1			センサ2			センサ3		
1	温度	28	°C	温度	13	%	圧力	798	
2	湿度	78		圧力	757	hPa	70-		m/:
3	湿度	65	%	圧力	764	hPa	與紀度	67290	
4	圧力		hPa	照度	75967	b:	70-		m/:
5	温度	39.9	°C	圧力	703	hPa	温度	50	
6	温度	55.1	°C	貝科度	82554	bx .	70-		m/:
7	圧力	975	hPa	既度	86528	bc .	温度	76	%
8	温度	21	%	圧力	719	hPa	70-	44	m/1
9	温度	45.1	°C	圧力	820	hPa	照度	61944	k
10	温度	44	%	温度	57.3	°C	70-	47	m/
11	照度	37966	b:	温度	43	5.	圧力	708	hPa
12	温度	51	5	圧力	1032	hPa	温度	53.6	°C
13	20-	27	m/s	圧力	737	hPa	見日(18)	48839	bc .
14	圧力	938	bPa	與程度	69350	b:	70-	18	m/
15	温度	58.9	°C	圧力	911	hPa	70-	73	m/
16	温度	25.3	°C	88時	43771	k	20-	43	m/
17	圧力	852	hPa	見記書	96070	by .	温度	86	5
18	湿度	98	5	圧力	807	hPa	温度	34.4	°C
19	混度	85	5	温度	58.6	°C	70 -	87	m/
20	温度	99	¥.	圧力	722	hPa	温度	543	°C.

Fig. 1. Monitoring Screen

Summary

- Verified the basic architecture. Standardization awaited.
- 2 More sensors are to come: Particle, Differential pressure, etc..
- ③ Further power reduction expected by new CPU & sensors.



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